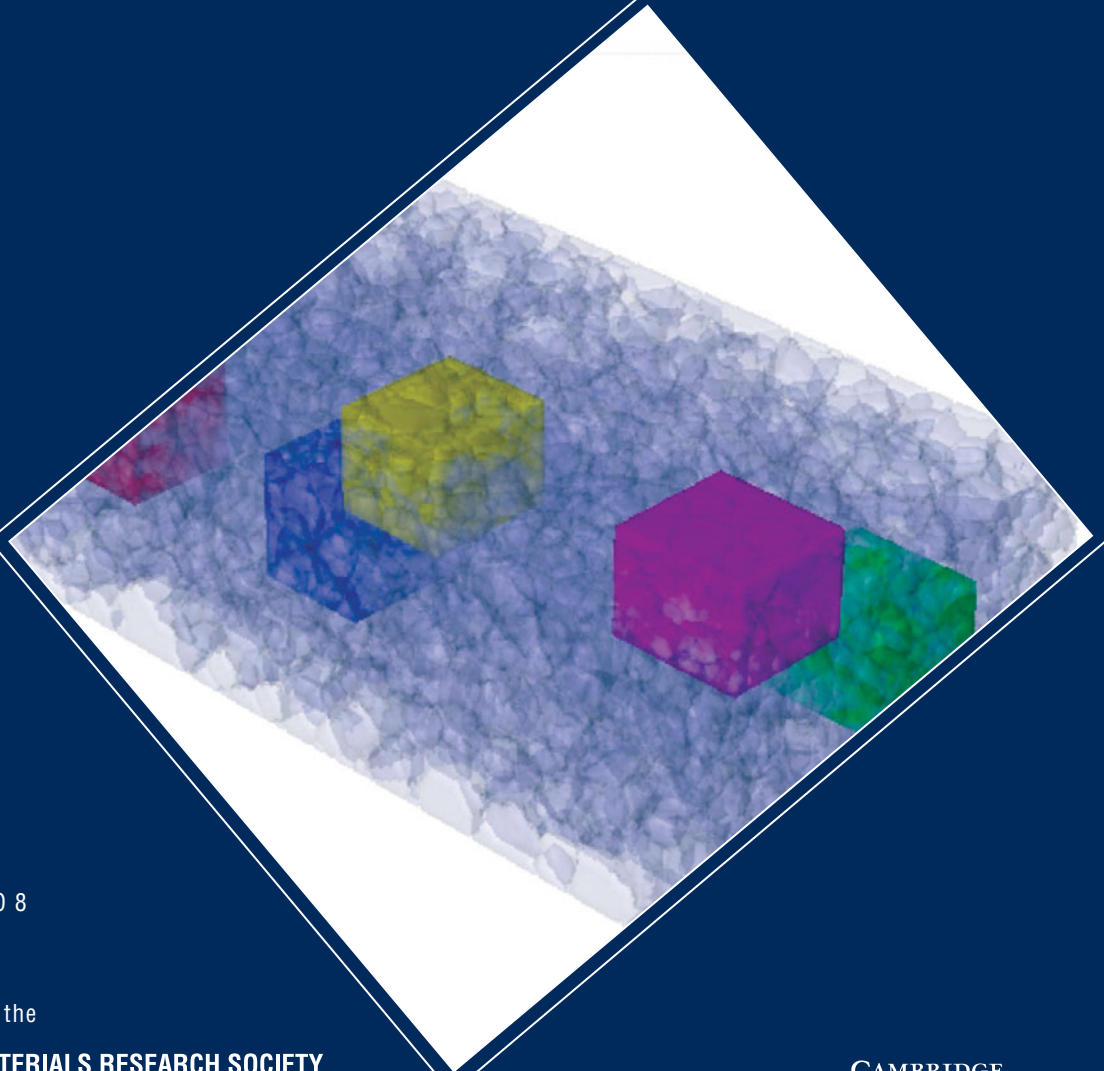




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Journal of MATERIALS RESEARCH

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Cover: Three-dimensional reconstruction of polycrystalline β -Ti microstructure, showing the location of five randomly selected sub-volumes. [A.C. Lewis, S.M. Qidwai, D.J. Rowenhorst, and A.B. Geltmacher: Correlation between crystallographic orientation and mechanical response in a three-dimensional β -Ti microstructure. p. 957.]

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